

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**  
(Not for submission under 37 CFR 1.99)

Application Number	10542040
Filing Date	2006-02-06
First Named Inventor	John Mize
Art Unit	1795
Examiner Name	Jason Berman
Attorney Docket Number	H0004870.70759 US -4015

**U.S. PATENTS**

Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
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## U.S. PATENT APPLICATION PUBLICATIONS

Examiner Initial*	Cite No	Publication Number	Kind Code <sup>1</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
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	2	20050098427	A1	2005-05-12	Taiwan Semiconductor Manufacturing Co., Ltd.	
	3	20050284756	A1	2005-12-29	Len Hom, et al.	
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#### FOREIGN PATENT DOCUMENTS

Examiner Initial*	Cite No	Foreign Document Number <sup>3</sup>	Country Code <sup>2</sup>	Kind Code <sup>4</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear	T <sup>5</sup>
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#### EXAMINER SIGNATURE

Examiner Signature	/Jason Berman/	Date Considered	07/15/2009
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